



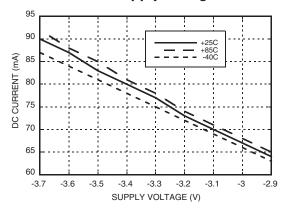
13 Gbps, FAST RISE TIME D-TYPE FLIP-FLOP w/ PROGRAMMABLE OUTPUT VOLTAGE

Electrical Specifications, (continued)

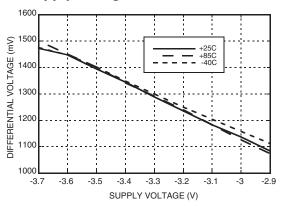
Parameter	Conditions	Min.	Тур.	Max	Units
Output Low Voltage			-570		mV
Output Rise / Fall Time	Differential, 20% - 80%		19 / 17		ps
Output Return Loss	Frequency <13 GHz		10		dB
Random Jitter Jr	rms			0.2	ps rms
Deterministic Jitter, Jd	peak-to-peak, 2 ¹⁵ -1 PRBS input ^[1]		2		ps, pp
Propagation Delay Clock to Data, td			105		ps
Clock Phase Margin	13 GHz		320		deg
Set Up & Hold Time, t _{SH}			6		ps

^[1] Deterministic jitter calculated by simultaneously measuring the jitter of a 300 mV, 13 GHz, 2¹⁵-1 PRBS input, and a single-ended output

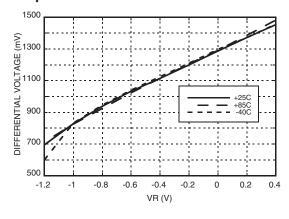
DC Current vs. Supply Voltage [1] [2]



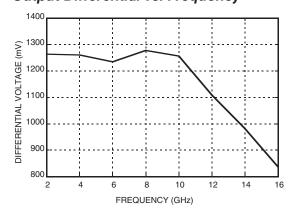
Output Differential vs. Supply Voltage [1] [3]



Output Differential vs. VR [3]



Output Differential vs. Frequency [1]



[1] VR = 0.0V

[2] Frequency = 13 GHz

[3] Frequency = 10 GHz

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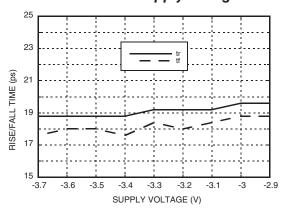
For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D



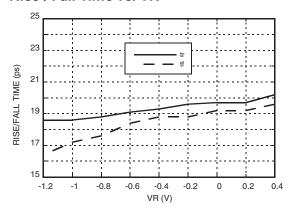


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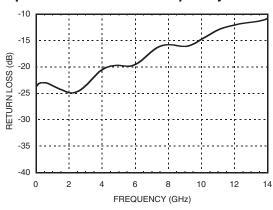
Rise / Fall Time vs. Supply Voltage [2]



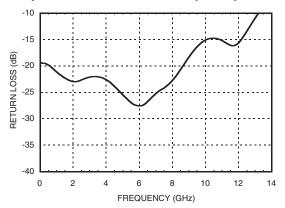
Rise / Fall Time vs. VR [2]



Input Return Loss vs. Frequency



Output Return Loss vs. Frequency



[1] VR = 0.0V

[2] Frequency = 13 GHz

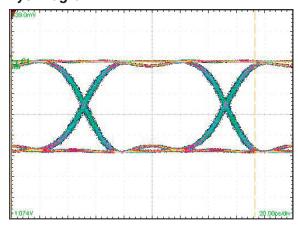
[3] Frequency = 10 GHz





13 Gbps, FAST RISE TIME D-TYPE FLIP-FLOP w/ PROGRAMMABLE OUTPUT VOLTAGE

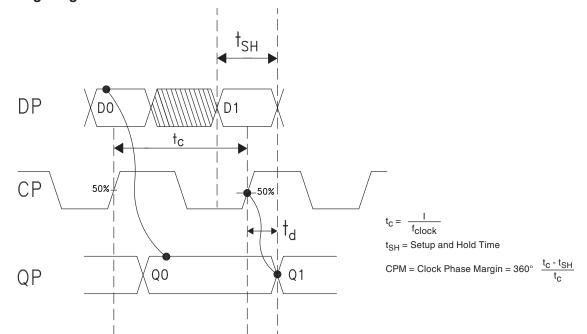
Eye Diagram



[1] Test Conditions:

Pattern generated with an Agilent N4903A Serial BERT. Eye Diagram presented on a Tektronix CSA 8000. Device input = 13 Gbps PN code, Vin = 300mVp-p differential. Both output channels shown.

Timing Diagram



Truth Table

Input		Outputs	
D	С	Q	
L	L -> H	L	
Н	L -> H	Н	
Notes: D = DP - DN C = CP - CN Q = QP - QN	H - Positive voltage level L - Negative voltage level		





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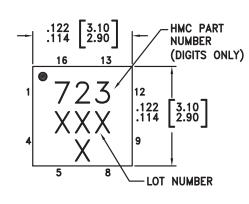
Absolute Maximum Ratings

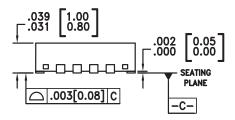
Power Supply Voltage (Vee)	-3.75V to +0.5V	
Input Signals	-2V to +0.5V	
Output Signals	-1.5V to +1V	
Storage Temperature	-65°C to +150°C	
Operating Temperature	-40°C to +85°C	

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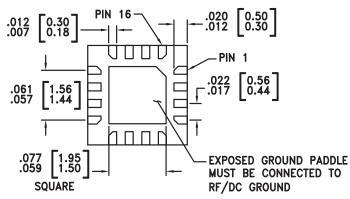


Outline Drawing





BOTTOM VIEW



NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC723LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	723 XXXX

- [1] Max peak reflow temperature of 235 $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX





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Pin Descriptions

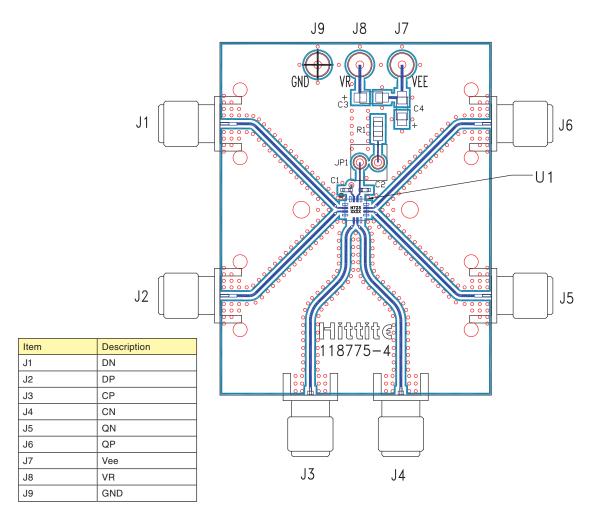
Pin Number	Function	Description	Interface Schematic
1, 4, 5, 8, 9, 12	GND	Signal Grounds	⊖ GND =
2, 3	DN, DP	Data Inputs	GND 500 DN, ODP
6, 7	CP, CN	Clock Inputs	GND 500 CP, CN
10, 11	QN, QP	Data Outputs	GND 50Ω QP, QN
13, 16	GND	Supply Ground	GND =
14	VR	Output level control. Output level may be adjusted by either applying a voltage to VR per "Output Differential vs. VR" plot, or by tying VR to GND with a resistor per the following equation: $V_0(R) = 1.2 / (2.1 + R)$, R in k Ω	VR 0
15, Package Base	Vee	Negative Supply	





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Evaluation PCB



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List of Materials for Evaluation PCB 118777 [1]

Item	Description	
J1 - J6	PCB Mount SMA RF Connectors	
J7 - J9	DC Pin	
C1, C2	100 pF Capacitor, 0402 Pkg.	
C3, C4	4.7 μF Capacitor, Tantalum	
R1	10 Ohm Resistor, 0603 Pkg.	
U1	HMC723LP3E High Speed Logic, D-Type Flip-Flop	
PCB [2]	118775 Evaluation Board	

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed package base should be connected to Vee. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350 or Arlon 25FR





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Application Circuit

